

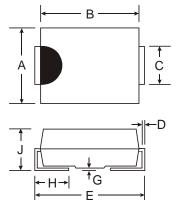
ES3A/AB - ES3D/DB 3.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Features

- Glass Passivated Die Construction
- Super-Fast Recovery Time For High Efficiency
- Surge Overload Rating to 100A Peak
- Ideally Suited for Automated Assembly
- Lead Free Finish/RoHS Compliant (Note 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SMB/SMC
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Lead Free Plating (Matte Tin Finish).
 Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band or Cathode Notch
- Marking Information: See Page 3
- Ordering Information: See Page 3
- SMB Weight: 0.093 grams (approximate)
- SMC Weight: 0.21 grams (approximate)



Dim	SN	ИΒ	SMC				
	Min	Max	Min	Max			
Α	3.30	3.94	5.59	6.22			
В	4.06	4.57	6.60	7.11			
С	1.96	2.21	2.75	3.18			
D	0.15	0.31	0.15	0.31			
E	5.00	5.59	7.75	8.13			
G	0.10	0.20	0.10	0.20			
Н	0.76	1.52	0.76	1.52			
J	2.00	2.62	2.00	2.62			
All Dimensions in mm							

A, B, C, D, Suffix Designates SMC Package AB, BB, CB, DB Suffix Designates SMB Package

Maximum Ratings and Electrical Characteristics

@T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic		Symbol	ES3A/AB	ES3B/BB	ES3C/CB	ES3D/DB	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 5)		V _{RRM} V _{RWM} V _R	50	100	150	200	V
RMS Reverse Voltage		V _{R(RMS)}	35	70	105	140	V
Average Rectified Output Current @ T _T = 100°C		lo	3.0				Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load		I _{FSM}	100				Α
Maximum Forward Voltage	$@ I_F = 3.0A$	V_{FM}	0.9				V
Peak Reverse Current at Rated DC Blocking Voltage (Note 5)	@ T _A = 25°C @ T _A = 125°C	I _{RM}	10 500				μА
Maximum Reverse Recovery Time (Note 3)		t _{rr}	25				ns
Typical Total Capacitance (Note 2)		C _T	45				pF
Typical Thermal Resistance, Junction to Terminal		$R_{ heta JT}$	10				°C/W
Typical Thermal Resistance, Junction to Ambient (Note 1)		$R_{\theta JA}$	50			°C	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150				°C

Notes:

- 1. Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.
- 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 3. Measured with $I_F = 0.5A$, $I_R = 1.0A$, $I_{rr} = 0.25A$. See Figure 5.
- 4 EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 5. Short duration pulse test used to minimize self-heating effect.



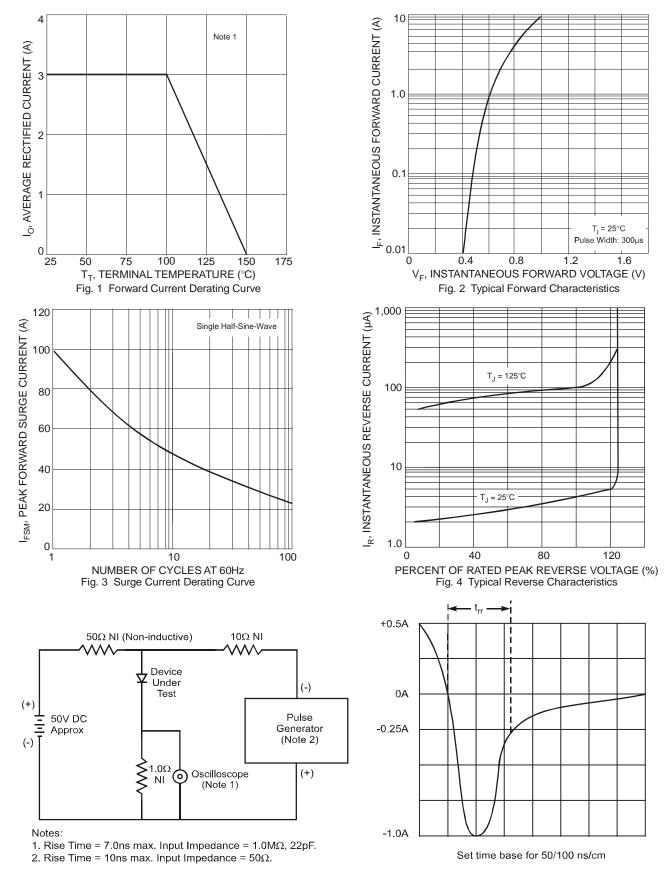


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit



Ordering Information (Note 6)

Device*	Packaging	Shipping		
ES3x-13-F	SMC	3000/Tape & Reel		
ES3xB-13-F	SMB	3000/Tape & Reel		

^{*} x = Device type, e.g. ES3A-13-F (SMC package); ES3AB-13-F (SMB package).

6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf. Notes:

Marking Information



ES3X = Product type marking code, ex: ES3A (SMC package) ES3XB = Product type marking code, ex: ES3AB (SMB package)

D!! = Manufacturers' code marking

YWW = Date code marking Y = Last digit of year ex: 2 for 2002

WW = Week code 01 to 52

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